

INTERNATIONAL
GEMOLOGICAL
INSTITUTE

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LABORATORY GROWN DIAMOND REPORT

October 27, 2025

IGI Report Number

DESCRIPTION

Shape and Cutting Style

Measurements

GRADING RESULTS

Carat Weight

Color Grade

Clarity Grade

ADDITIONAL GRADING INFORMATION

Polish

Symmetry

Fluorescence

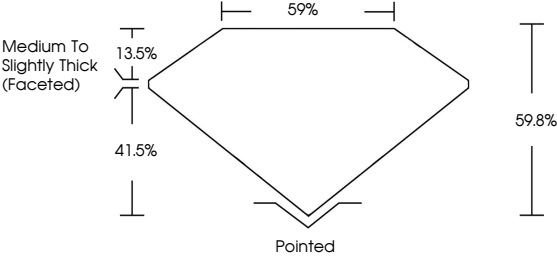
Inscription(s)

Comments: As Grown - No indication of post-growth treatment.
This Laboratory Grown Diamond was created by High Pressure High Temperature (HPHT) growth process.
Type II

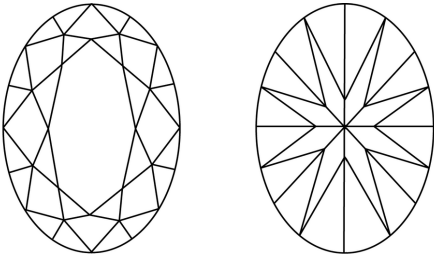
LG745506993

Report verification at [igi.org](#)

PROPORTIONS



CLARITY CHARACTERISTICS



KEY TO SYMBOLS

Red symbols indicate internal characteristics.
Green symbols indicate external characteristics.

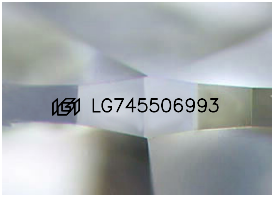
COLOR

D E F G H I J Faint Very Light Light

CLARITY

FL IF VVS 1-2 VS 1-2 SI 1-2 I 1-3

Flawless Internally Flawless Very Very Slightly Included Very Slightly Included Slightly Included Included



Sample Image Used

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Type II

EXCELLENT

EXCELLENT

NONE

LG745506993



IGI

October 27, 2025

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OVAL BRILLIANT

8.24 X 5.65 X 3.38 MM

Carat Weight

Color Grade

Clarity Grade

Table

Girdle

Medium to Slightly Thick (Faceted)

Pointed

EXCELLENT

EXCELLENT

NONE

IGI LG745506993

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Type II

1.01 CARAT

D

IF

59.8%

59%

41.5%

59.8%

EXCELLENT


EXCELLENT

NONE

IGI LG745506993

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